

General Description

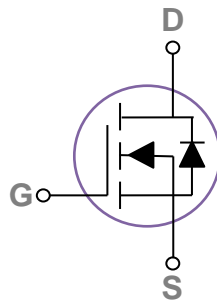
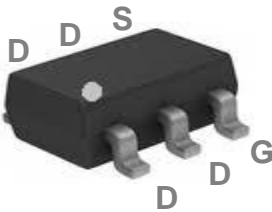
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BVDSS	RDSON	ID
100V	120mΩ	2.4A

Features

- 100V,2.4A, $R_{DS(ON)} = 120m\Omega$ @ $V_{GS} = 10V$
- Improved dv/dt capability
- Fast switching
- Green Device Available

SOT23-6 Pin Configuration



Applications

- MB / VGA / Vcore
- Load Switch
- Hand-Held Instrument

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current – Continuous ($T_A=25^\circ\text{C}$)	2.4	A
	Drain Current – Continuous ($T_A=75^\circ\text{C}$)	1.8	A
I_{DM}	Drain Current – Pulsed ¹	9.6	A
P_D	Power Dissipation ($T_A=25^\circ\text{C}$)	1.56	W
	Power Dissipation – Derate above 25°C	0.012	W/ $^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	80	$^\circ\text{C/W}$

Electrical Characteristics (T_J=25 °C, unless otherwise noted)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	100	---	---	V
ΔBV _{DSS} /ΔT _J	BV _{DSS} Temperature Coefficient	Reference to 25°C, I _D =1mA	---	0.04	---	V/°C
I _{DSS}	Drain-Source Leakage Current	V _{DS} =100V, V _{GS} =0V, T _J =25°C	---	---	1	μA
		V _{DS} =80V, V _{GS} =0V, T _J =125°C	---	---	10	μA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	---	---	±100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance ³	V _{GS} =10V, I _D =1A	---	94	120	mΩ
		V _{GS} =4.5V, I _D =0.5A	---	96	130	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250μA	1.2	1.7	2.5	V
ΔV _{GS(th)}	V _{GS(th)} Temperature Coefficient		---	-5	---	mV/°C
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =1A	---	4	---	S

Dynamic and switching Characteristics

Q _g	Total Gate Charge ^{2, 3}	V _{DS} =50V, V _{GS} =10V, I _D =2A	---	21.2	40	nC
Q _{gs}	Gate-Source Charge ^{2, 3}		---	3.1	6	
Q _{gd}	Gate-Drain Charge ^{2, 3}		---	5	10	
T _{d(on)}	Turn-On Delay Time ^{2, 3}	V _{DD} =50V, V _{GS} =10V, R _G =3.3Ω I _D =1A	---	18	36	ns
T _r	Rise Time ^{2, 3}		---	4	8	
T _{d(off)}	Turn-Off Delay Time ^{2, 3}		---	40	80	
T _f	Fall Time ^{2, 3}		---	3	6	
C _{iss}	Input Capacitance	V _{DS} =25V, V _{GS} =0V, F=1MHz	---	1400	2800	pF
C _{oss}	Output Capacitance		---	60	120	
C _{rss}	Reverse Transfer Capacitance		---	35	70	
R _g	Gate resistance		V _{GS} =0V, V _{DS} =0V, F=1MHz	---	2	

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _S	Continuous Source Current	V _G =V _D =0V, Force Current	---	---	2.5	A
I _{SM}	Pulsed Source Current ²		---	---	5	A
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V, I _S =1A, T _J =25°C	---	---	1	V
t _{rr}	Reverse Recovery Time	V _{GS} =0V, I _S =1A, di/dt=100A/μs, T _J =25°C	---	46	---	ns
Q _{rr}	Reverse Recovery Charge		---	50	---	nC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
3. Essentially independent of operating temperature.

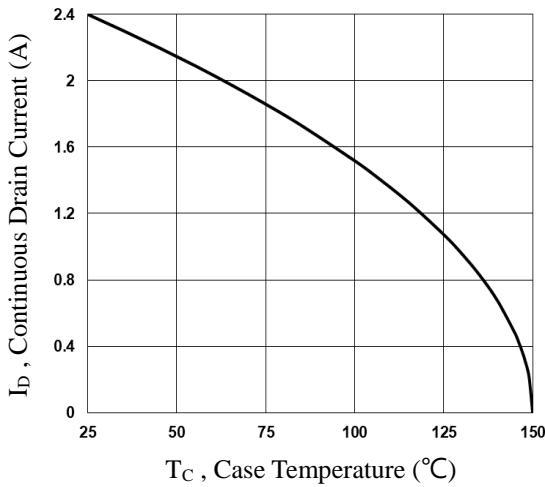


Fig.1 Continuous Drain Current vs. T_c

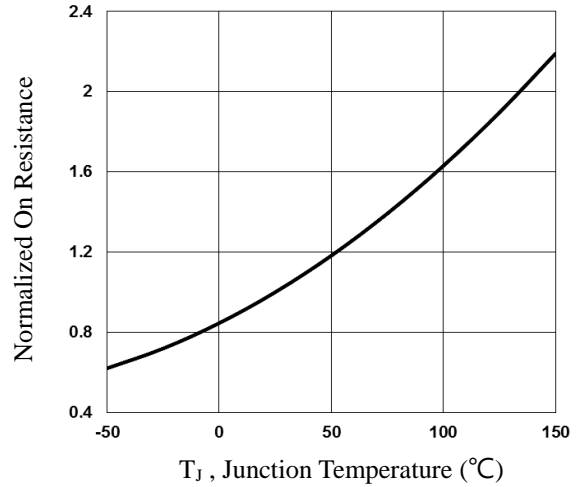


Fig.2 Normalized $R_{DS(on)}$ vs. T_J

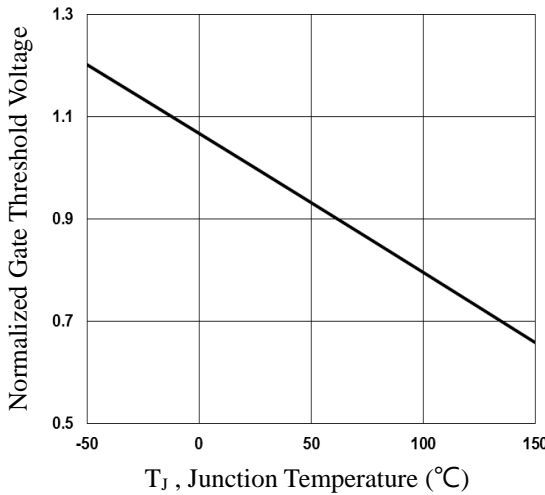


Fig.3 Normalized V_{th} vs. T_J

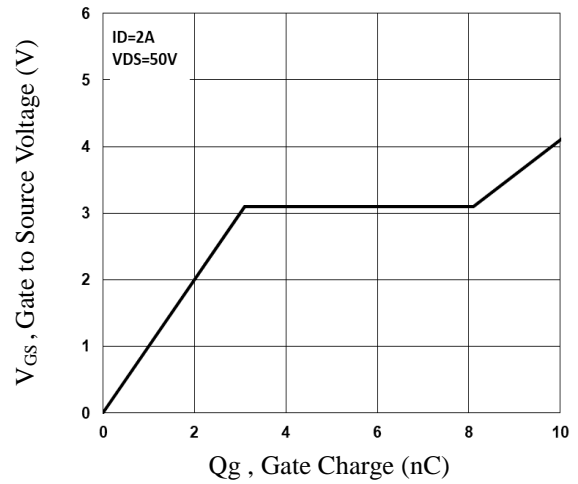


Fig.4 Gate Charge Waveform

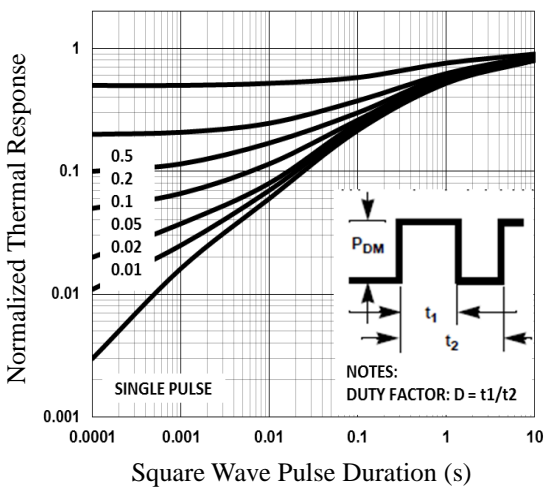


Fig.5 Normalized Transient Response

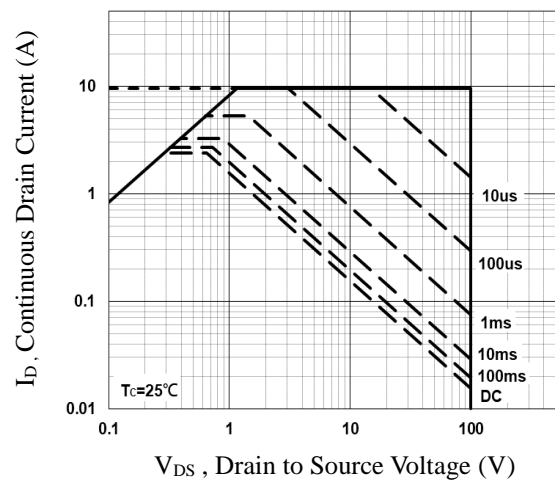


Fig.6 Maximum Safe Operation Area



Fig.7 Switching Time Waveform

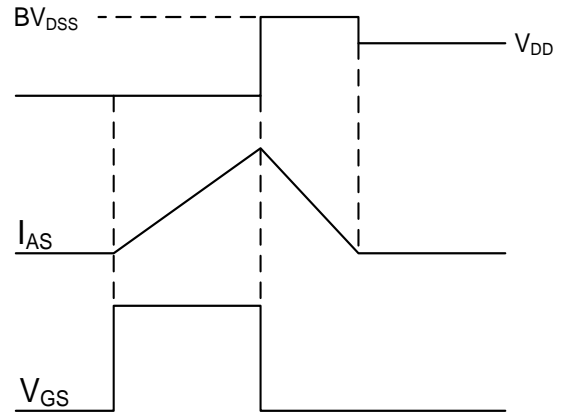
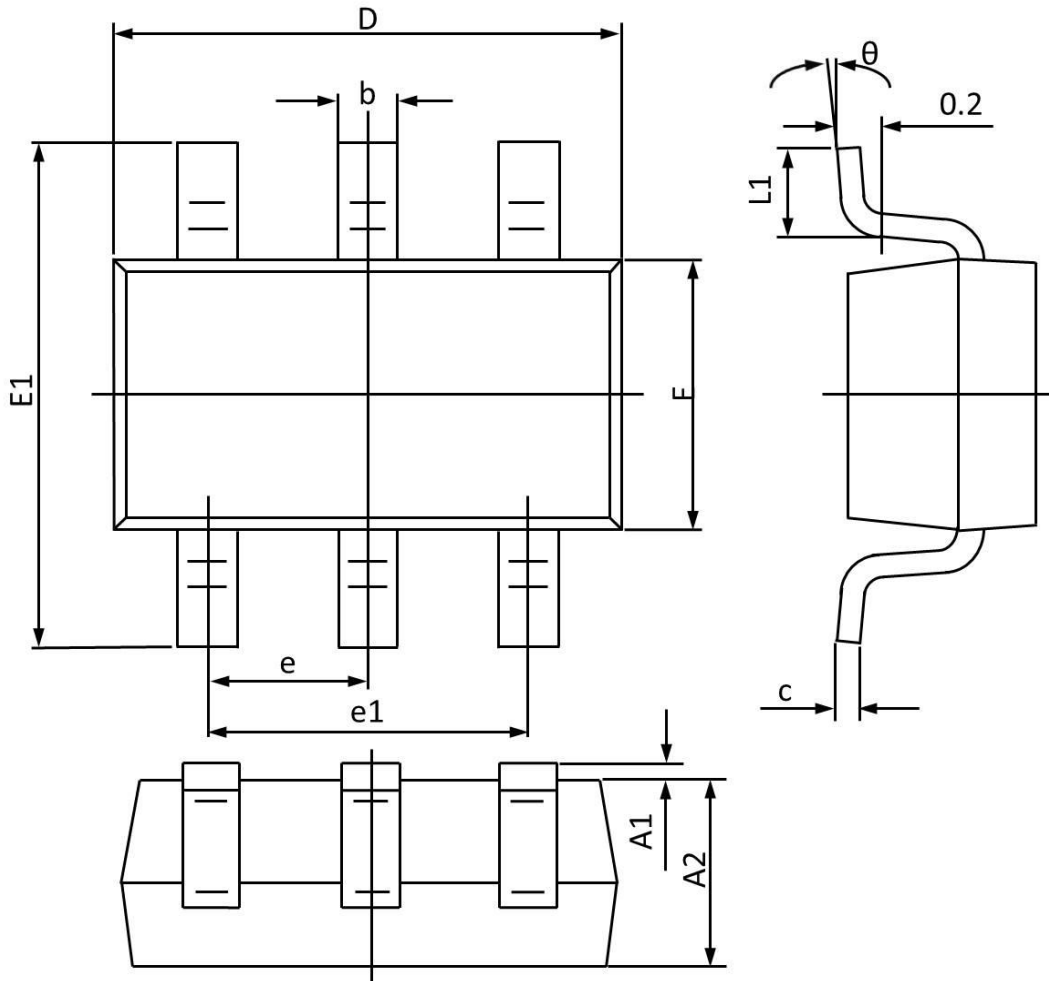


Fig.8 EAS Waveform

SOT23-6 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A1	---	0.150	---	0.006
A2	0.900	1.300	0.035	0.051
b	0.300	0.500	0.012	0.019
c	0.100	0.200	0.004	0.008
D	2.800	3.050	0.110	0.120
E1	2.600	3.000	0.103	0.118
F	1.500	1.800	0.059	0.071
e	0.950 TYP		0.037 TYP	
e1	1.900 TYP		0.075 TYP	
L1	0.250	0.600	0.010	0.024
θ	0°	8°	0°	8°